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## FFB20UP30DN

## 20 A, 300 V, Ultrafast Dual Diode

#### **Features**

- Ultrafast Recovery,  $t_{rr}$  = 45 ns (@  $I_F$  = 10 A)
- Max Forward Voltage, V<sub>F</sub> = 1.3 V (@ T<sub>C</sub> = 25°C)
- Reverse Voltage: V<sub>RRM</sub> = 300 V
- · Avalanche Energy Rated
- · RoHS Compliant

#### **Applications**

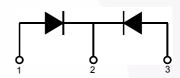
- · General Purpose
- · SMPS,Welder
- · Free-Wheeling Diode for Motor Application
- · Power Switching Circuits

### **Description**

The FFB20UP30DN is an ultrafast dual diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applicationa as welder application.



1.Anode 2.Cathode 3.Anode



1. Anode 2. Cathode 3. Anode

#### Absolute Maximum Ratings (per diode) T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit
$V_{RRM}$	Peak Repetitive Reverse Voltage	300	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	300	V
V <sub>R</sub>	DC Blocking Voltage	300	V
I <sub>F(AV)</sub>	Average Rectified Forward Current (per Diode) @T <sub>C</sub> = 130°C	10	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	180	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +175	°C

#### **Thermal Characteristics**

Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.0	°C/W

#### **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFB20UP30DNTM	F20UP30DN	D <sup>2</sup> -PAK	Reel	13" Dia	N/A	800

## **Electrical Characteristics** (per diode) $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Min.	Тур.	Max.	Unit	
V <sub>F</sub> *	I <sub>F</sub> = 10 A I <sub>F</sub> = 10 A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 150 °C	-	-	1.3 1.2	V V
I <sub>R</sub> *	V <sub>R</sub> = 300 V V <sub>R</sub> = 300 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 150 °C	-	-	1 500	μ <b>Α</b> μ <b>Α</b>
T <sub>rr</sub>	I <sub>F</sub> =0.5 A, I <sub>rr</sub> =1 A, V <sub>CC</sub> = 30 V I <sub>F</sub> =1 A, di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 30 V I <sub>F</sub> =10 A, di <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 195 V	$T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 25  ^{\circ}\text{C}$		- - -	30 35 45	ns ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 195\text{V}$	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$	- - -	11 13 20	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 20 mH)	•	20	-	-	mJ

<sup>\*</sup>Pulse Test: Pulse Width=300 μs, Duty Cycle=2%

#### **Test Circuit and Waveforms**

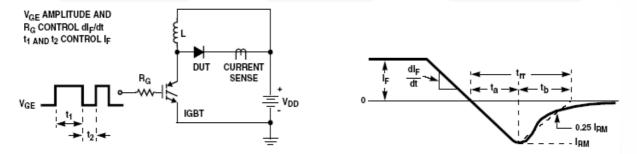


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

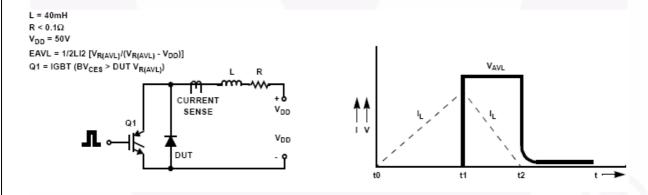


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

## **Typical Performance Characteristics**

Figure 3. Typical Forward Voltage Drop

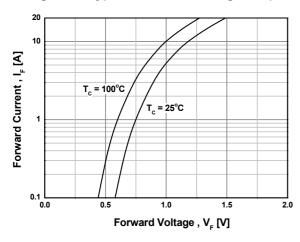


Figure 4. Typical Reverse Current

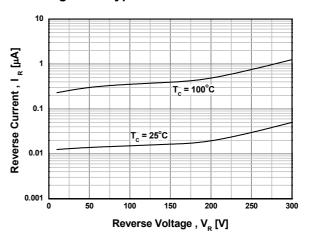


Figure 5. Typical Junction Capacitance

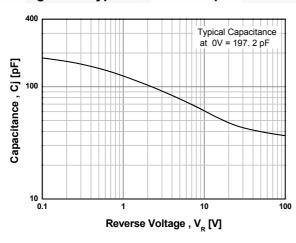


Figure 6. Typical Reverse Recovery Time

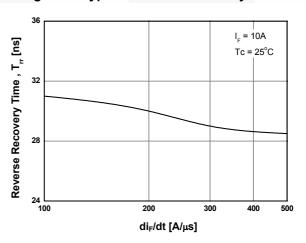
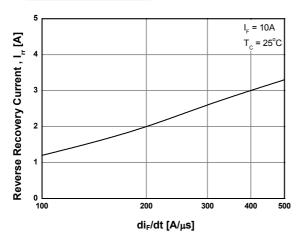
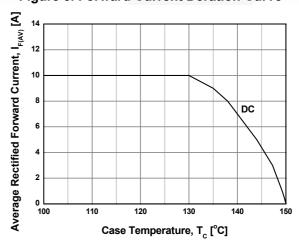
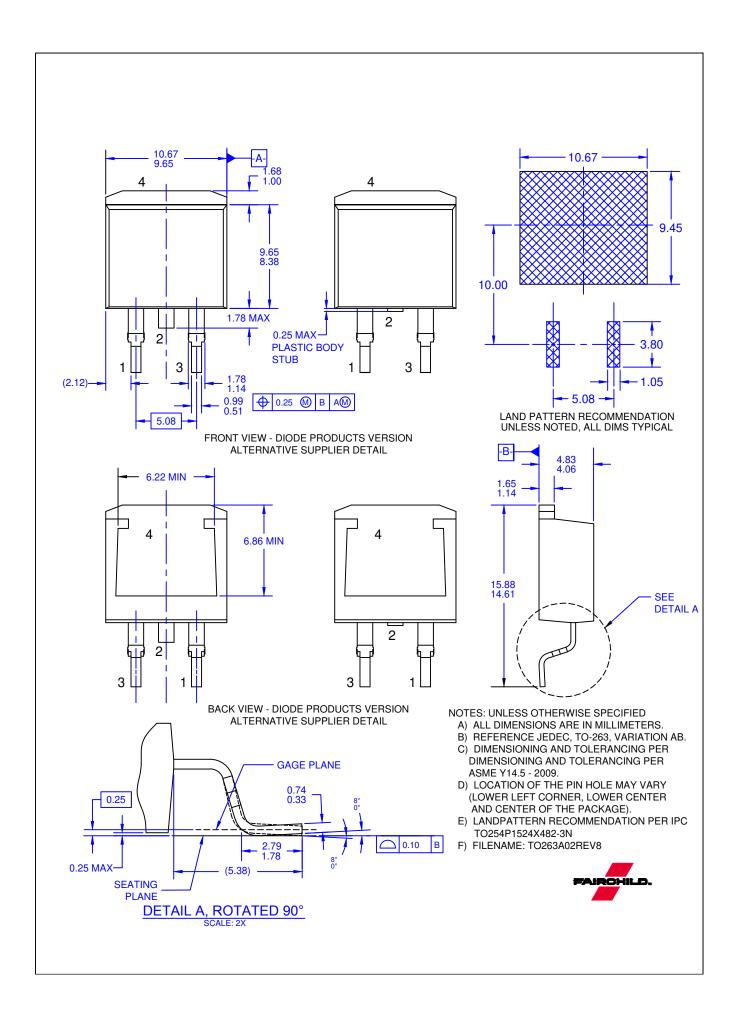


Figure 7. Typical Reverse Recovery Current



**Figure 8. Forward Current Deration Curve** 





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